# **Power MOSFET**

# 20 V, 890 mA, Single N-Channel with **ESD Protection, SOT-723**

### **Features**

- N-Channel Switch with Low R<sub>DS(on)</sub>
- 44% Smaller Footprint and 38% Thinner than SC89
- Low Threshold Levels Allowing 1.5 V R<sub>DS(on)</sub> Rating
- Operated at Low Logic Level Gate Drive
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### **Applications**

- Load/Power Switching
- Interface Switching
- Logic Level Shift
- Battery Management for Ultra Small Portable Electronics

### **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise stated)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			$V_{DSS}$	20	V	
Gate-to-Source Volt	Gate-to-Source Voltage			± 6	V	
Continuous Drain	Steady	, ,		890	mA	
Current (Note 1)	State	T <sub>A</sub> = 85°C		640		
	t ≤ 5 s	T <sub>A</sub> = 25°C		990		
Power Dissipation (Note 1)	Steady State	T <sub>A</sub> = 25°C	P <sub>D</sub>	450	mW	
	t ≤ 5 s			550		
Continuous Drain	Steady State	T <sub>A</sub> = 25°C	I <sub>D</sub>	750	mA	
Current (Note 2)	State	T <sub>A</sub> = 85°C		540		
Power Dissipation (Note 2)		T <sub>A</sub> = 25°C	P <sub>D</sub>	310	mW	
Pulsed Drain Current	t <sub>p</sub> = 10 μs		I <sub>DM</sub>	1.8	Α	
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>STG</sub>	–55 to 150	°C	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)
- 2. Surface mounted on FR4 board using the minimum recommended pad size

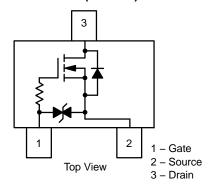


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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> TYP	I <sub>D</sub> Max		
20 V	0.20 Ω @ 4.5 V	890 mA		
	0.26 Ω @ 2.5 V	790 mA		
	0.43 Ω @ 1.8 V	700 mA		
	0.56 Ω @ 1.5 V	200 mA		

### SOT-723 (3-LEAD)





SOT-723 CASE 631AA STYLE 5

### MARKING DIAGRAM



= Specific Device Code = Date Code

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTK3134NT1G	SOT-723*	4000 / Tape & Reel
NTK3134NT5G	SOT-723*	8000 / Tape & Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.
- \*These packages are inherently Pb-Free.

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 3)	$R_{ hetaJA}$	280	°C/W
Junction-to-Ambient - t = 5 s (Note 3)	$R_{ heta JA}$	228	
Junction-to-Ambient - Steady State Minimum Pad (Note 4)	$R_{ heta JA}$	400	

<sup>3.</sup> Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)
4. Surface mounted on FR4 board using the minimum recommended pad size

## **MOSFET ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition	n	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V, } I_D = 250  \mu\text{A}$		20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	$I_D$ = 250 $\mu$ A, Reference to 25°C			18		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25°C			1.0	μΑ
		$V_{DS} = 16 \text{ V}$	T <sub>J</sub> = 125°C			2.0	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm$	4.5 V			±0.5	μΑ
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$ , $I_D = 25$	50 μΑ	0.45		1.2	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				2.4		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 89$	90 mA		0.20	0.35	Ω
		$V_{GS} = 2.5 \text{ V}, I_D = 78$	80 mA		0.26	0.45	
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 70	00 mA		0.43	0.65	
		$V_{GS} = 1.5 \text{ V}, I_D = 20$	$V_{GS} = 1.5 \text{ V}, I_D = 200 \text{ mA}$		0.56	1.2	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 800 mA			1.6		S
CHARGES, CAPACITANCES AND G	SATE RESISTAN	ICE					
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 16 V			79	120	pF
Output Capacitance	C <sub>OSS</sub>				13	20	
Reverse Transfer Capacitance	C <sub>RSS</sub>				9.0	15	
SWITCHING CHARACTERISTICS, V <sub>GS</sub> = 4.5 V (Note 6)							
Turn On Delay Time	t <sub>d(ON)</sub>	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}, I_D = 500 \text{ mA},$			6.7		ns
Rise Time	t <sub>r</sub>	$R_G = 10 \Omega$			4.8		
TurnOff Delay Time	t <sub>d(OFF)</sub>				17.3		
Fall Time	t <sub>f</sub>				7.4		
DRAIN SOURCE DIODE CHARACTERISTICS							
Forward Diode Voltage	$V_{SD}$	$V_{GS} = 0 \text{ V}, I_{S} = 350 \text{ mA}$	T <sub>J</sub> = 25°C		0.75	1.2	V
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = 0 \text{ V}, d_{ISD}/d_t = 100 \text{ A}/\mu\text{s},$ $I_S = 1.0 \text{ A}, V_{DD} = 20 \text{ V}$			8.1		ns
Charge Time	ta				6.4		
Discharge Time	t <sub>b</sub>				1.7		
Reverse Recovery Charge	$Q_{RR}$				3.0		nC
-							

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>5.</sup> Pulse Test: pulse width =  $300 \mu s$ , duty cycle = 2%

<sup>6.</sup> Switching characteristics are independent of operating junction temperatures

### **TYPICAL CHARACTERISTICS**

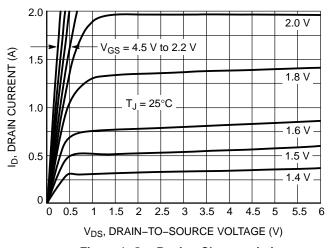


Figure 1. On-Region Characteristics

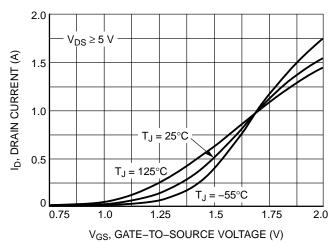


Figure 2. Transfer Characteristics

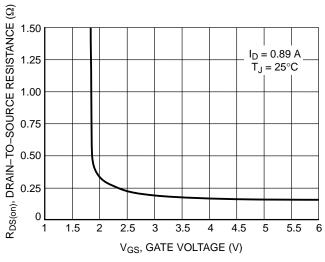


Figure 3. On-Resistance vs. Gate-to-Source Voltage

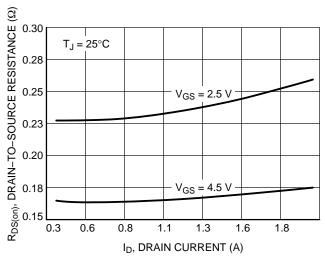


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

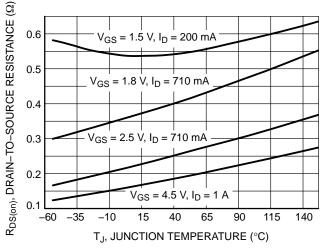


Figure 5. On–Resistance Variation with Temperature

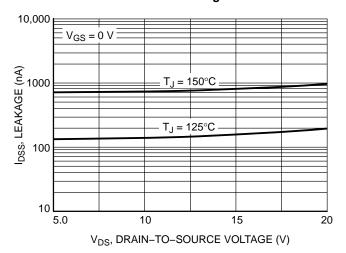


Figure 6. Drain-to-Source Leakage Current vs. Voltage

## **TYPICAL CHARACTERISTICS**

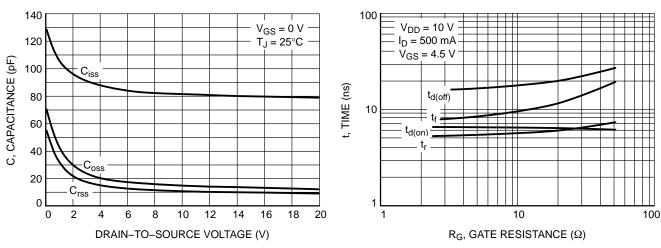


Figure 7. Capacitance Variation

Figure 8. Resistive Switching Time Variation vs. Gate Resistance

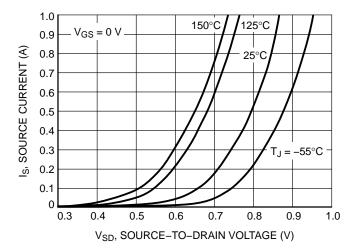
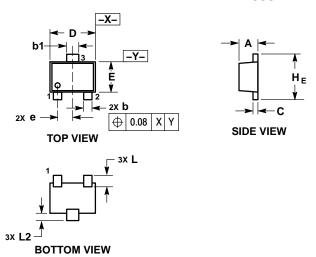


Figure 9. Diode Forward Voltage vs. Current

### PACKAGE DIMENSIONS

### SOT-723 CASE 631AA ISSUE D



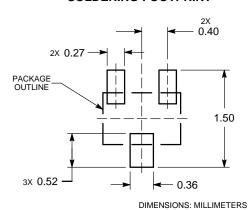
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- T 14.3M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.
  MAXIMUM LEAD THICKNESS INCLUDES LEAD
  FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM
  THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.45	0.50	0.55	
b	0.15	0.21	0.27	
b1	0.25	0.31	0.37	
С	0.07	0.12	0.17	
D	1.15	1.20	1.25	
Е	0.75	0.80	0.85	
е	0.40 BSC			
ΗE	1.15	1.20	1.25	
L	0.29 REF			
12	0.15	0.20	0.25	

STYLE 5: PIN 1. GATE 2. SOURCE

- 3. DRAIN

### RECOMMENDED **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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